

Product lines and standardization – the equipment supplier perspective

ADCSS2020

Patrik Sandin

RUAG Space

October 22, 2020

Together
ahead. **RUAG**

History

Looking back...

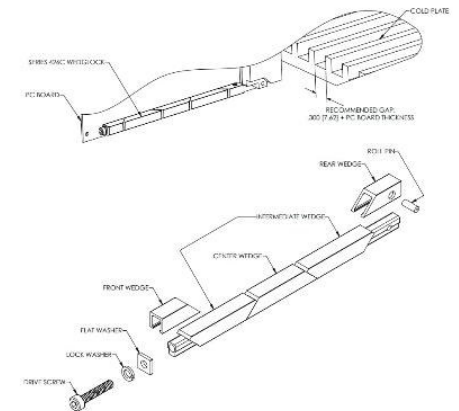
- An OBC was specified differently between each program and customer
 - In best case it was the same customer engineering teams @prime and @ESA then there was at least a chance for some commonality
 - Personal opinions of individual system engineers affected the acceptable technical solutions to a large extent
 - Not only mission specifics varied between missions

- What happened?
 - SAVOIR was formed and created a reference architecture and reference specifications
 - It is now a well-established foundation for at least ESA satellites
 - Now we have much less variation between missions – of course we still need to do mission specific adaptations
 - It is a competitive advantage to be able to handle mission specifics efficiently



What is the future?

- Is Advanced Data Handling Architecture (ADHA) the future?
 - It is a beginning at least...
- Modular architectures with standardized mechanical and electrical interfaces is the future!
- Is Compact PCI Serial Space the future?
- Is SpaceVPX the future?
- Is wedge-lock the future?
- Remember
 - A fully customized and optimized equipment targeting a specific mission will have better SWaP than equipment built on standardized concepts
 - Total costs will be much higher – is it worth it?



Together
ahead. **RUAG**

Standardization

What is it good for?



Standardization

What is it good for?

- Absolutely nothing
(Edwin Starr – War)



Standardization

What is it good for?

▪ What?

- **Electrical interfaces and communication protocols**
 - Both internal and external
- **Mechanical interfaces**
 - Both internal and external
- **Functions on a high level**
 - But be careful not to over specify
 - Must allow innovation, competition and evolution



▪ Why?

- **Increased reuse**
 - Complete crates and modules between units, missions and customers
- **Focus on what is important** – the mission specifics
 - We do not want to spend valuable time and effort on adapting electrical and mechanical interfaces unless it is necessary
- **Integration of more functions** in the same unit
 - Reducing DC/DC converters, mechanical housing and harness
- Develop modules for a **wider customer base**
 - Easy to get started no need to focus on mechanics and backplanes
 - Removing the cost of adapting to each customer
- Reuse of **qualification status**
 - At least reduce re-qualification efforts between units, missions and customers significantly
- **Faster, cheaper and better** – plug and play

Standardization

What is it not good for?

▪ What?

– Allocation of functions to modules or units

- Customers can have preferences but should not be standardized
- See Product Lines

– Performance



▪ Why not?

- It hampers **innovation, competition and evolution**
- We should **compete on technical solutions and flexibility** as well as **schedule and cost**

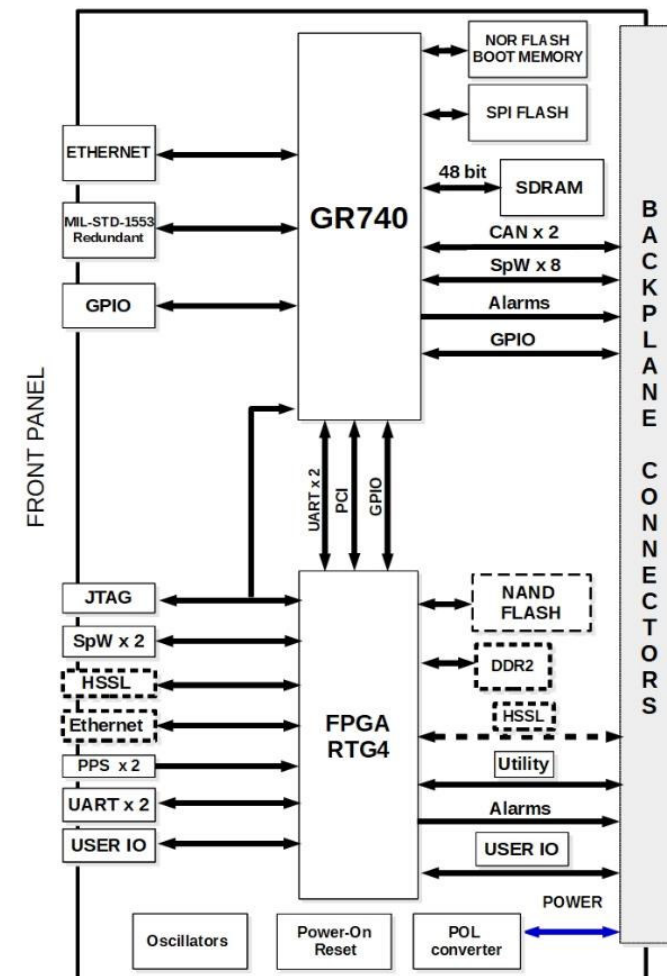


▪ Pitfalls

- Be careful if you standardize every little detail of each module to get drop-in replacements
- You could believe you get **dual sourcing** advantages on module level
 - But you only get dual manufacturing capability
- Your suppliers are reduced to **build-to-print shops**
- Your suppliers can only compete on **lowest manufacturing price**
- You are not really looking for the **advantages of standardization**

GR740 Single Board Computer Preliminary datasheet

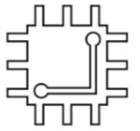
- A high performance Single-Board Computer based on Cobham Gaisler GR740 Quad-Core 32-bit LEON4FT SPARC V8 processor and Microsemi RTG4 radiation tolerant FPGA.
 - The SBC provides an extensive set of memories and redundant interfaces to support the needs of current and future OBC and Data Handling platforms.
 - Developed as part of ESA activity “Reference Design and Basic Software for a Single Board Computer based on GR740”
-
- Features
 - Implemented following the Compact PCI Serial Space backplane standard (CPCI-S.1 R1.0)
 - Dual star, eight SpaceWire interfaces from GR740
 - Multi drop bus, redundant CAN from GR740
 - Full mesh, HSSL (SpFI) from RTG4
 - Multi drop bus, I2C from RTG4
 - Alarms and other utility signals
 - On-board memory
 - SDRAM interfaced with GR740, 512 MiB of accessible data RAM plus ECC check bits
 - Parallel Boot MRAM, 64 KiB interfaced with GR740
 - SPI Flash memory, 32 MiB interfaced with GR740
 - 3D-PLUS NAND FLASH, 8 GiB interfaced with RTG4
 - 3D-PLUS DDR2, 512 MiB of accessible data RAM plus ECC check bits interfaced with RTG4
 - PCI, UART and GPIO interface between GR740 and RTG4
 - Interfaces at front edge of board:
 - Redundant MIL-STD-1553B
 - 2 x SpaceWire
 - Gigabit Ethernet
 - General purpose I/O's
 - PPS (Pulse Per Second) input for synchronization (SMB)
 - UART/JTAG debug interfaces
 - Form factor
 - 6U (233.5 mm x 160 mm), 5 HP. Mass 1.2 kg (estimate)
 - Power consumption: ~30 W (estimate)



Together
ahead. **RUAG**

High Performance Processing Modules

Lynx (ARM) Single Board Computer (SBC) datasheet



Key Features

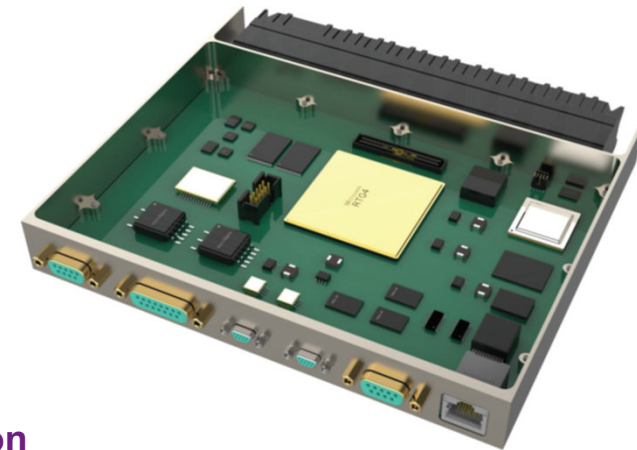
- Lynx SBC is a high-performance general-purpose single board computer with flexible communication and interface capabilities
- Processing capability provided by a quad core ARM processor delivering more than 30.000 DMIPS
- IO capability implemented in a reprogrammable FPGA allowing late tailoring to a specific program need (without hardware redesign) and hardware accelerated functionality.
- Designed for 15 years in GEO orbit
- RUAG has an extensive single-board computer heritage:
 - > 3000 failure free equipment years in orbit
 - > 300 Launcher On-Board Computers
 - > 120 Satellite Data Handling Systems

Budgets

- Form factor 6U-160, 5 HP, 234 x 160 x 25.4 mm
- Mass 1 kg incl. frame
- Power consumption 10-25 W

Radiation Tolerance

- Latch Up protected
- All memories with error correction
- Sustain total dose up to 15 years in GEO orbit



Specification

- ARM processor with 4 x CPU cores
 - >30.000 DMIPS
 - 32 KiB L1 instruction cache, 32 KiB L1 data cache, 2 MiB L2 cache
- 4/8 GiByte DDR4 processing memory with ECC
- 4/8/16 GiByte Flash memory with ECC
- 512 MiByte DDR2 communication memory with ECC
- Gigabit Ethernet Debug Link
- Interfaces:
 - Front connectors: 4 x SpaceWire, 2 x UART, 16 x GPIO (configurable), debug interfaces
 - Back-plane, cPCIss: 5 x HSSL @ 3 Gbps, 10 x SpaceWire, 2 x I2C, 6 x SPI, 2 x UART, 32 x GPIO
 - Mezzanine: Interfaces mezzanine (optional)
 - 2 x M1553B (optional), 2 x CAN (optional)

Product lines

What is it?

Very complex... or really simple...

- **Collection of different functions**
 - expected to be delivered from a supplier or
 - provided by a supplier matching customer needswith defined and described features
 - Not standardized
- **Can be**
 - **A hardware module**
 - **A mechanical crate with a backplane**
 - **A complete unit**
 - Crate, backplane and modules
 - **Software or gateway module or package**
 - **A subsystem**



- **Pitfalls** (same as for standardization)
 - Too **rigid definitions** of product lines from higher level entities will hamper **innovation and competition**
 - Product lines must allow **different implementations and evolution**
- **SAVOIR reference architecture**
 - A good example of how to standardize functions and use as a basis for product lines
 - Physical allocation is not defined – which is good
- **Equipment data sheet => Customer product line database/catalogue**

Equipment supplier role

Standardization and product lines

- **Equipment suppliers will be reduced to module suppliers**
 - Both ESA and prime have aired such thoughts in the scope of ADHA
 - This is a big misconception
- **Equipment suppliers will**
 - Continue to deliver efficient and cost-effective solutions for units and subsystems
 - Take advantage of the standardization
 - Build units and sub-systems from standard crates, backplanes and modules
 - Compete on technical solutions and flexibility as well as schedule and cost



Conclusion

- **Modular architectures with standardized mechanical and electrical interfaces is the future!**
- Standardize
 - **Electrical interfaces and communication protocols**
 - **Mechanical interfaces**
 - **Functions on a high level**
- Allow **evolution**, **competition** on **innovation** and **implementation**
- **Equipment suppliers** will continue to deliver **efficient** and **cost-effective units** and **sub-systems**

